

1.6X0.8mm SMD CHIP LED LAMP (0.25mm Height)

PRELIMINARY SPEC

Part Number: KPG-1608SURKC-T

Hyper Red

Features

- 1.6mmX0.8mm SMT LED, 0.25mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

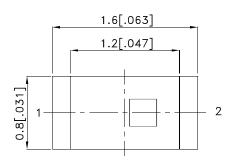
Description

The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

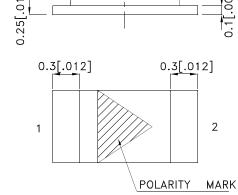
Applications

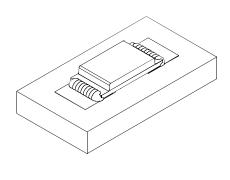
- 1. Mobile phone Keypad indicator and backlight.
- 2.Flat backlight for LCD, switch and symbol.
- 3.Toys.

Package Dimensions









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAI7025 **REV NO: V.2 DATE: MAR/19/2009** PAGE: 1 OF 5 **CHECKED: Allen Liu** APPROVED: WYNEC DRAWN: S.P.Chen ERP: 1203008082

Selection Guide

Part No.	Dice	lv (mcd) [2] Dice Lens Type @ 20mA		,	Viewing Angle [1]
		-	Min.	Тур.	2θ1/2
KPG-1608SURKC-T	Hyper Red (AlGaInP)	WATER CLEAR	180	320	120°

Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	630		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2	2.5	V	IF=20mA
lR	Reverse Current	Hyper Red		10	uA	V _R =5V

Notes:

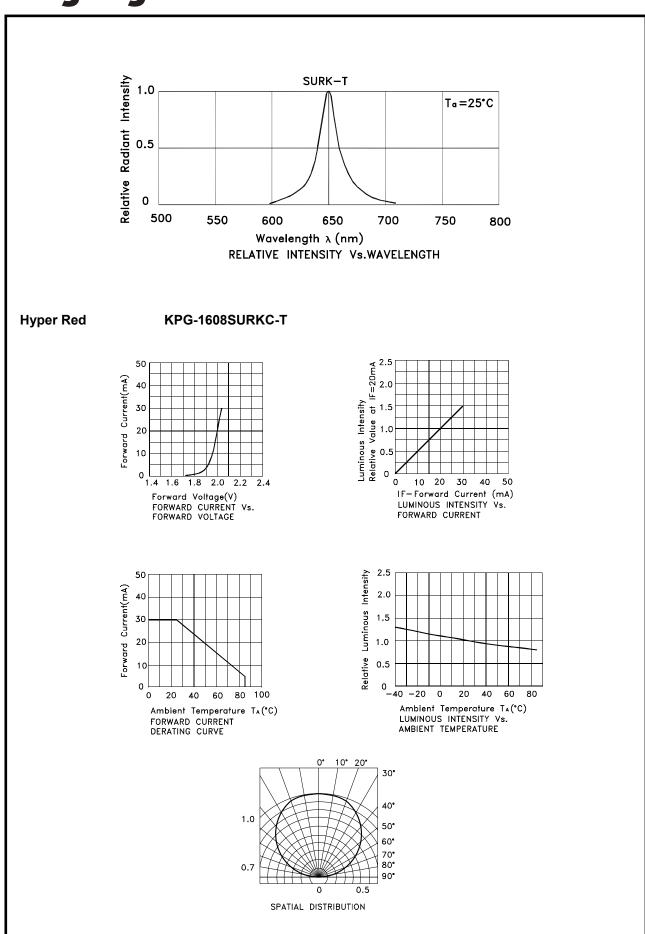
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Autobiato maximum raumgo at 171 20 0					
Hyper Red	Units				
75	mW				
30	mA				
150	mA				
5	V				
-40°C To +85°C					
-40°C To +85°C					
	75 30 150 5 -40°C To +85°C				

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAI7025 **REV NO: V.2** DATE: MAR/19/2009 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: S.P.Chen ERP: 1203008082



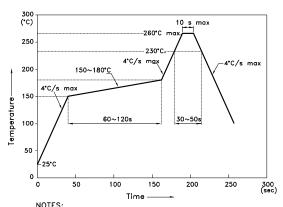
 SPEC NO: DSAI7025
 REV NO: V.2
 DATE: MAR/19/2009
 PAGE: 3 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: S.P.Chen
 ERP: 1203008082

KPG-1608SURKC-T

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



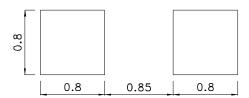
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

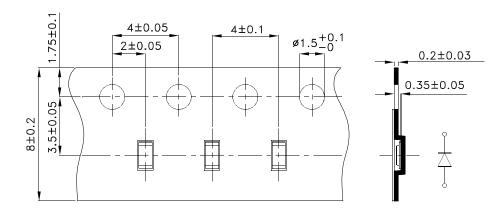
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

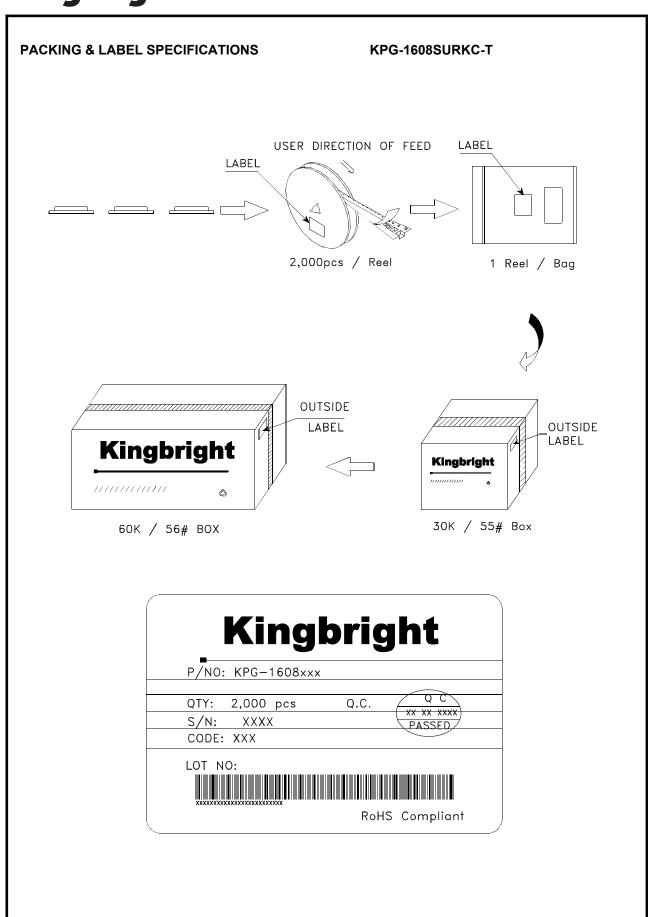


Tape Dimensions (Units: mm)

TAPE



SPEC NO: DSAI7025 **REV NO: V.2 DATE: MAR/19/2009** PAGE: 4 OF 5 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: S.P.Chen ERP: 1203008082



SPEC NO: DSAI7025 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu DATE: MAR/19/2009 DRAWN: S.P.Chen PAGE: 5 OF 5 ERP: 1203008082